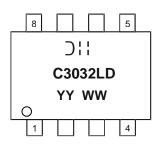


Marking Information



Maximum Ratings N-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 5)	Steady State	T _A = +25°C T _A = +85°C	Ι _D	8.1 5.1	А
Pulsed Drain Current (Note 6)			I _{DM}	25	А

Maximum Ratings P-CHANNEL – Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	-30	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 5)	Steady State	T _A = +25°C T _A = +85°C	Ι _D	-7.0 -4.5	А
Pulsed Drain Current (Note 6)			I _{DM}	-25	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	2.5	W
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	50	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Notes: 5. Device mounted on FR-4 PCB, with minimum recommended pad layout. 6. Repetitive rating, pulse width limited by junction temperature.

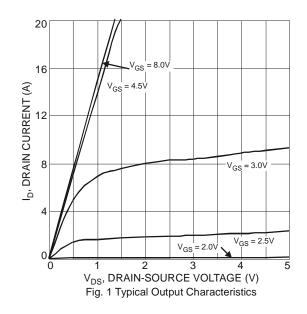


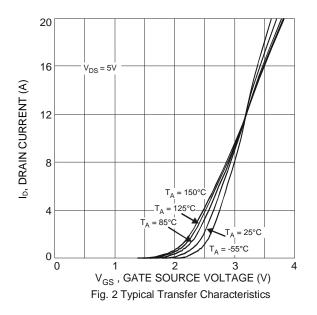
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Electrical Characteristics N-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	—	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}		-	1	μA	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	1	1.45	2.1	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Statia Duaia Causa On Desistance			23	32		V _{GS} = 10V, I _D = 7A	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	32	46	mΩ	V _{GS} = 4.5V, I _D = 5.6A	
Forward Transfer Admittance	Y _{fs}	_	7.6		S	$V_{DS} = 5V, I_D = 7A$	
Diode Forward Voltage (Note 7)	V _{SD}		0.7	1	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 8)			•			·	
Input Capacitance	Ciss	—	404.5		pF		
Output Capacitance	Coss	—	51.8	_	pF	− V _{DS} = 15V, V _{GS} = 0V, − f = 1MHz	
Reverse Transfer Capacitance	Crss		45.1		pF		
Gate Resistance	Ra		1.5		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (10V)	Qq		9.2		nC		
Gate-Source Charge	Q _{gs}		1.2		nC	$V_{GS} = 10V, V_{DS} = 15V,$	
Gate-Drain Charge	Q _{gd}		1.8	—	nC	$I_{D} = 5.8A$	
Turn-On Delay Time	t _{D(ON)}		3.4		ns		
Turn-On Rise Time	t _R	_	6.18		ns	$V_{GS} = 10V, V_{DS} = 15V,$	
Turn-Off Delay Time	t _{D(OFF)}	—	13.92	_	ns	$R_G = 3\Omega, R_L = 2.6\Omega$	
Turn-Off Fall Time	t _F	_	2.84		ns		

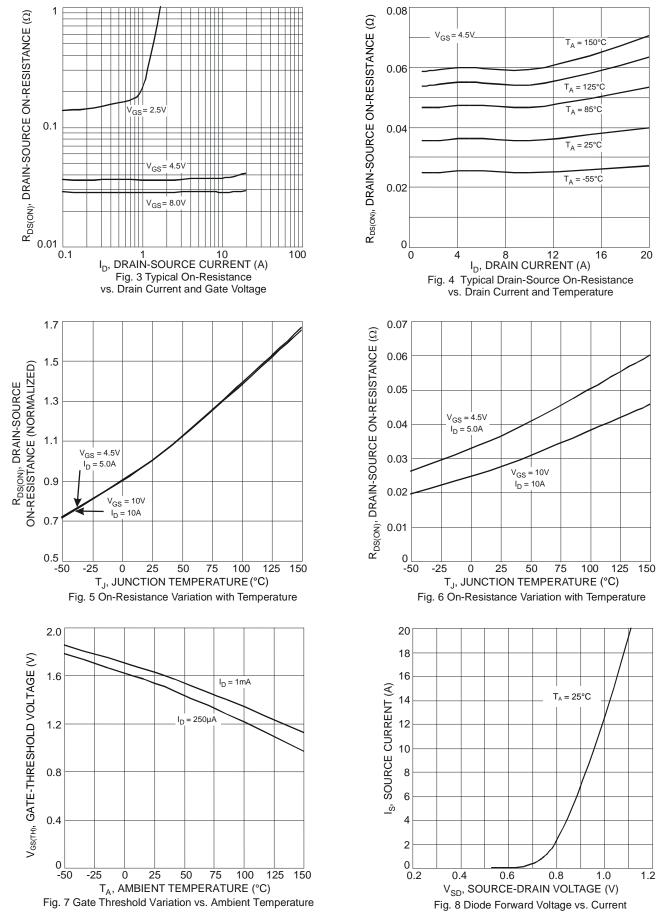
Notes: 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to production testing.







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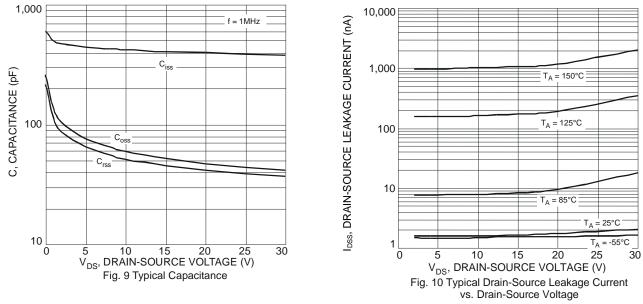


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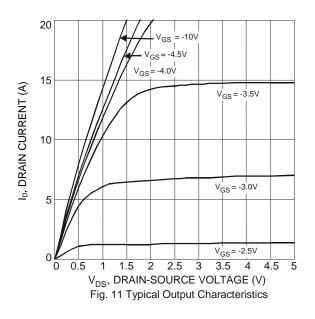


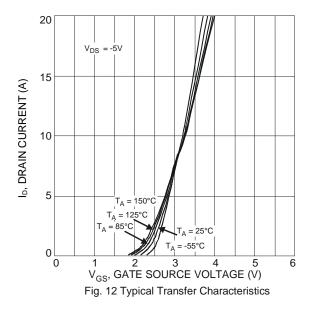


Electrical Characteristics P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

n						-	
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	_	V	$V_{GS} = 0V, I_D = -250 \mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	_	_	-1	μA	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}		—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	-1	-1.7	-2.2	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$	
Static Drain-Source On-Resistance			30	39	mΩ	$V_{GS} = -10V, I_D = -4.3A$	
	R _{DS(ON)}		42	53	11152	$V_{GS} = -4.5V, I_D = -3.7A$	
Forward Transfer Admittance	Y _{fs}		7		S	$V_{DS} = -5V, I_D = -4.3A$	
Diode Forward Voltage (Note 7)	V _{SD}	_	-0.75	-1	V	$V_{GS} = 0V, I_{S} = -1.7A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		1002	_	pF		
Output Capacitance	Coss	-	125	_	pF	V _{DS} = -15V, V _{GS} = 0V, f = 1MHz	
Reverse Transfer Capacitance	C _{rss}		118	—	рF		
Gate Resistance	Rg		13	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (-4.5V)	Qg		10.1	_	nC		
Total Gate Charge (-10V)	Qg	-	21.1	_	nC	V _{GS} = -4.5V/-10V, V _{DS} = -15V,	
Gate-Source Charge	Q _{gs}	—	2.8	_	nC	I _D = -6A	
Gate-Drain Charge	Q _{gd}	—	3.2	_	nC		
Turn-On Delay Time	t _{D(ON)}	—	10.1	_	ns		
Turn-On Rise Time	t _R	_	6.5		ns	V _{GS} = -10V, V _{DS} = -15V,	
Turn-Off Delay Time	t _{D(OFF)}	_	50.1		ns	$R_G = 6\Omega$, $I_D = -1A$	
Turn-Off Fall Time	tF	_	22.2	_	ns		

Notes: 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to production testing.

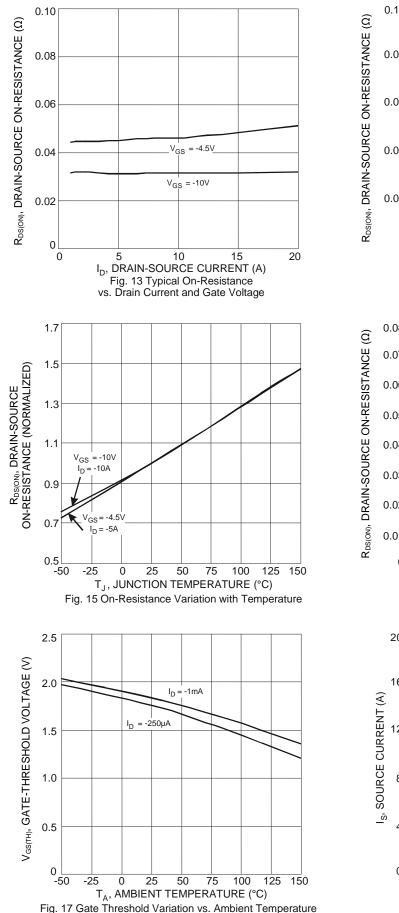






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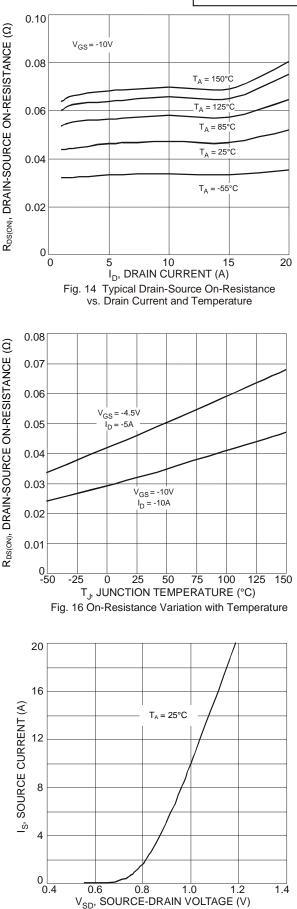


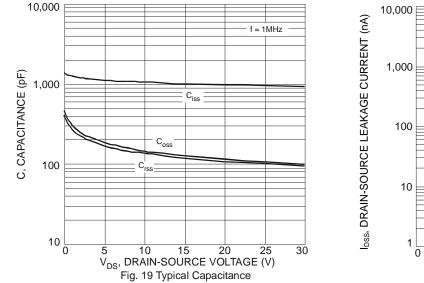
Fig. 18 Diode Forward Voltage vs. Current

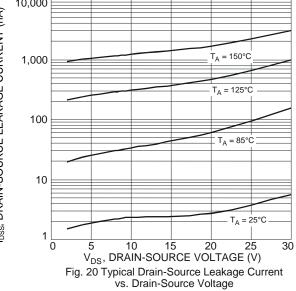
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DMC3032LSD







Тур

1.45

0.15

0.40

0.20

4.90

6.00

3.85

3.90

1.27

0.35

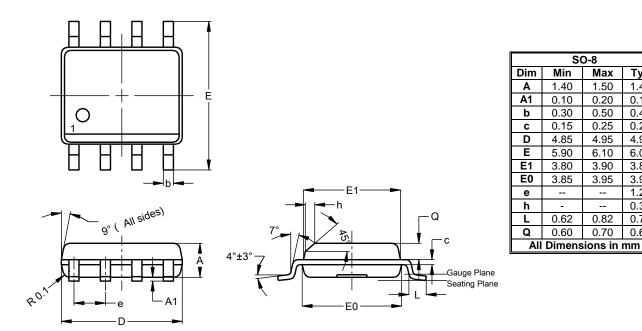
0.72

0.65

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

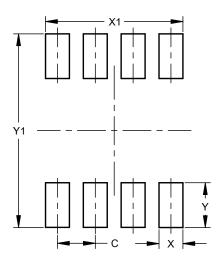
SO-8



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8



Dimensions	Value (in mm)				
С	1.27				
Х	0.802				
X1	4.612				
Y	1.505				
Y1	6.50				



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